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Yes
No 6. Total number of applications and patents involved: 1 5. Name and address of party to whom correspondence concerning document should be mailed: \$40.00 7. Total fee (37 CFR 3.41): ⊠ Enclosed Douglas P. Mueller Name: Merchant & Gould P.C. Authorized to be charged to deposit account Address: P.O. Box 2903 8. Please charge any additional fees or credit any Minneapolis, MN 55402-0903 overpayments to our Deposit account number: 13-2725 DO NOT USE THIS SPACE 9. Statement and signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. February 24, 2004 Douglas P. Mueller Date Name of Person Signing Signature Total number of pages including cover sheet, attachments, and document: 3 Do not detach this portion

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FORM PTO-1595

(Rev. 6-93)

PATENT TRADEMARK OFFICE

PATENT REEL: 015024 FRAME: 0992

INSTRUCTIONS

ASSIGNMENT OF U.S. RIGHTS TO CORPORATION

WHEREAS,

Inventor(s) Name, Address, Citizenship

- 1. <u>Toshihiro NAKAMURA</u> residing at <u>7-1-206</u>, <u>Miyano-cho, Takatsuki-shi,</u> <u>Osaka 569-0081</u>, <u>JAPAN</u> and a citizen of <u>JAPAN</u>;
- 2. <u>Kiyoto OTA</u> residing at <u>15-5</u>, <u>Shibatani-cho</u>, <u>Takatsuki-shi</u>, <u>Osaka 569-1025</u>, <u>JAPAN</u> and a citizen of JAPAN;
- 3. <u>Masahisa IIDA</u> residing at <u>7-1-548</u>, <u>Miyano-cho</u>, <u>Takatsuki-shi</u>, <u>Osaka</u> 569-0081, JAPAN and a citizen of JAPAN;
- 4. <u>Kenichi ORIGASA</u> residing at <u>1-3-24</u>, <u>Okutenjin-cho, Takatsuki-shi, Osaka 569-1118</u>, <u>JAPAN</u> and a citizen of <u>JAPAN</u>;

Date Patent Declaration Signed and Title Serial No. and filing date (if known) (herein called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States on for this invention, which application is entitled SEMICONDUCTOR MEMORY DEVICE, AND SEMICONDUCTOR DEVICE WITH THE SEMICONDUCTOR MEMORY DEVICE AND LOGIC CIRCUIT DEVICE THEREIN

and which has been given Serial Number		and the filing
date of	;	•

Name of Corporation

AND WHEREAS <u>Matsushita Electric Industrial Co., Ltd.</u> (herein called "ASSIGNEE"), a corporation organized under the laws of <u>JAPAN</u>, and having an office and place of business at <u>1006</u>, <u>Oaza Kadoma</u>, <u>Kadoma-shi</u>, <u>Osaka 571-8501</u>, <u>JAPAN</u>

State or Country of Incorporation and Address

wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign and transfer to the ASSIGNEE, its successors and assigns, the entire right, title and interest for the United States in and to the invention disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents to issue any and all United States Letters Patent for the aforesaid invention to the ASSIGNEE of the entire right, title and interest in and to the same, for the use of the ASSIGNEE, its successors and assigns.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to THE UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns the entire right, title and interest in and to the said invention, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE its successors and assigns, that no assignment grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by THE UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by THE UNDERSIGNED.

PATENT REEL: 015024 FRAME: 0993 IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Toshihipo NAKAMURA February 15, 2004

Each inventor must sign & date

Note: No legalization or other witness required

Kiyoto Ota Signature

Masahisa Iida

Merrick Crigaso

February 15, 200

Date Tebruary (5, 200)

February 15, 2004

February 15, 2004

PATENT REEL: 015024 FRAME: 0994

RECORDED: 02/24/2004